IGBT - Field Stop

600 V, 60 A

FGH60N60SFD

Description

Using novel field stop IGBT technology, ON Semiconductor's field stop IGBTs offer the optimum performance for solar inverter, UPS, welder and PFC applications where low conduction and switching losses are essential.

Features

- High Current Capability
- Low Saturation Voltage: $V_{CE(sat)} = 2.3 \text{ V} @ I_C = 60 \text{ A}$
- High Input Impedance
- Fast Switching
- This Device is Pb-Free and is RoHS Compliant

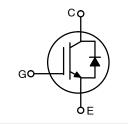
Applications

• Solar Inverter, UPS, Welder, PFC



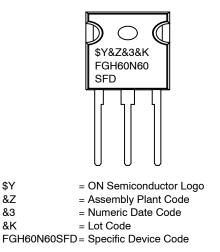
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MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

ABSOLUTE MAXIMUM RATINGS (T_C = 25° C unless otherwise noted)

Descriptio	Description			
Collector to Emitter Voltage		V _{CES}	600	V
Gate to Emitter Voltage		V _{GES}	±20	V
Transient Gate-to-Emitter Voltage		1 1	±30	
Collector Current	$T_{\rm C} = 25^{\circ}{\rm C}$	Ι _C	120	А
Collector Current	T _C = 100°C	1 1	60	А
Pulsed Collector Current	$T_{\rm C} = 25^{\circ}{\rm C}$	I _{CM} (Note 1)	180	А
Maximum Power Dissipation	$T_{\rm C} = 25^{\circ}{\rm C}$	PD	378	W
Maximum Power Dissipation	T _C = 100°C	7 F	151	W
Operating Junction Temperature		TJ	-55 to +150	°C
Storage Temperature Range		T _{stg}	-55 to +150	°C
Maximum Lead Temp. for Soldering Purpose	es, 1/8" from Case for 5 Seconds	ΤL	300	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Repetitive test, Pulse width limited by max. junction temperature.

THERMAL CHARACTERISTICS

Parameter	Symbol	Тур	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$ (IGBT)	-	0.33	°C/W
Thermal Resistance, Junction to Case	$R_{\theta JC}$ (Diode)	-	1.1	°C/W
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	-	40	°C/W

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FGH60N60SFDTU	FGH60N60SFD	TO-247	Tube	N/A	N/A	30

ELECTRICAL CHARACTERISTICS OF THE IGBT (T_C = 25°C unless otherwise noted)

Symbol	Test Conditions	Min	Тур	Max	Unit		
DFF CHARACTERISTICS							
BV _{CES}	V_{GE} = 0 V, I _C = 250 μ A	600	-	-	V		
$\Delta BV_{CES}/\Delta T_{J}$	V_{GE} = 0 V, I _C = 250 μ A	-	0.4	_	V/°C		
I _{CES}	$V_{CE} = V_{CES}, V_{GE} = 0 V$	-	-	250	μA		
I _{GES}	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	±400	nA		
	BV _{CES} ΔBV _{CES} /ΔTJ	$BV_{CES} \qquad V_{GE} = 0 \text{ V, } I_C = 250 \mu\text{A}$ $\Delta BV_{CES} / \Delta T_J \qquad V_{GE} = 0 \text{ V, } I_C = 250 \mu\text{A}$ $I_{CES} \qquad V_{CE} = V_{CES}, V_{GE} = 0 \text{ V}$	BV _{CES} V _{GE} = 0 V, I _C = 250 μA 600 ΔBV _{CES} /ΔT _J V _{GE} = 0 V, I _C = 250 μA - I _{CES} V _{CE} = V _{CES} , V _{GE} = 0 V -	$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	BV _{CES} V _{GE} = 0 V, I _C = 250 μA 600 - - ΔBV _{CES} /ΔT _J V _{GE} = 0 V, I _C = 250 μA - 0.4 - I _{CES} V _{CE} = V _{CES} , V _{GE} = 0 V - - 250		

ON CHARACTERISTICs

G-E Threshold Voltage	V _{GE(th)}	I_C = 250 μ A, V_{CE} = V_{GE}	4.0	5.0	6.5	V
Collector to Emitter Saturation Voltage	V _{CE(sat)}	$I_{\rm C}$ = 60 A, $V_{\rm GE}$ = 15 V	-	2.3	2.9	V
		I_C = 60 A, V_{GE} = 15 V, T_C = 125°C	-	2.5	-	V

ELECTRICAL CHARACTERISTICS OF THE IGBT	Γ (T _C = 25°C unless otherwise noted) (continued)
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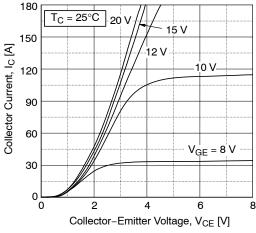
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
DYNAMIC CHARACTERISTICS		•				
Input Capacitance	C _{ies}	V_{CE} = 30 V, V_{GE} = 0 V, f = 1 MHz	-	2820	-	pF
Output Capacitance	C _{oes}	7	-	350	-	pF
Reverse Transfer Capacitance	C _{res}	7	-	140	-	pF
SWITCHING CHARACTERISTICS						
Turn-On Delay Time	t _{d(on)}	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 60 \text{ A},$ $R_{G} = 5 \Omega, \text{ V}_{GE} = 15 \text{ V},$ Inductive Load, $T_{C} = 25^{\circ}\text{C}$	-	22	-	ns
Rise Time	t _r		-	42	-	ns
Turn-Off Delay Time	t _{d(off)}		-	134	-	ns
Fall Time	t _f		-	31	62	ns
Turn-On Switching Loss	E _{on}		-	1.79	-	mJ
Turn-Off Switching Loss	E _{off}		-	0.67	-	mJ
Total Switching Loss	E _{ts}			2.46	-	mJ
Turn-On Delay Time	t _{d(on)}	$V_{\rm CC} = 400 \text{ V}, \text{ I}_{\rm C} = 60 \text{ A},$	-	22	-	ns
Rise Time	tr	$R_G = 5 \Omega$, $V_{GE} = 15 V$, Inductive Load, $T_C = 125^{\circ}C$	-	44	-	ns
Turn-Off Delay Time	t _{d(off)}	7	-	144	-	ns
Fall Time	t _f	7	-	43	-	ns
Turn-On Switching Loss	E _{on}	7	-	1.88	-	mJ
Turn-Off Switching Loss	E _{off}	7	-	1.0	-	mJ
Total Switching Loss	E _{ts}	1	-	2.88	-	mJ
Total Gate Charge	Qg	V_{CE} = 400 V, I _C = 60 A, V _{GE} = 15 V	-	198	-	nC
Gate to Emitter Charge	Q _{ge}	1	-	22	-	nC
Gate to Collector Charge	Q _{gc}	7	-	106	-	nC

ELECTRICAL CHARACTERISTICS OF THE DIODE (T_J = 25°C unless otherwise noted)

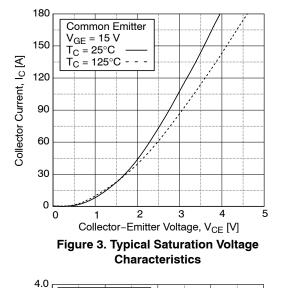
Symbol	Parameter	Test Condition	Test Conditions		Тур	Max	Unit
V _{FM}	Diode Forward Voltage	I _F = 30 A	$T_C = 25^{\circ}C$	-	2.0	2.6	V
			T _C = 125°C	-	1.8	-	
t _{rr}	Diode Reverse Recovery Time	$I_F = 30 \text{ A}, \text{ di}_F/\text{dt} = 200 \text{ A}/\mu\text{s}$	$T_{C} = 25^{\circ}C$	-	47	-	ns
			T _C = 125°C	-	179	-	
Q _{rr}	Diode Reverse Recovery Charge		$T_{C} = 25^{\circ}C$	-	83	-	nC
			T _C = 125°C	-	567	-	

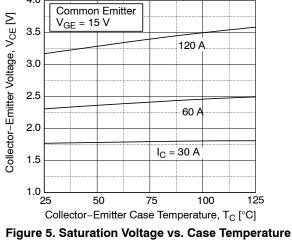
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

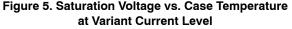
TYPICAL PERFORMANCE CHARACTERISTICS











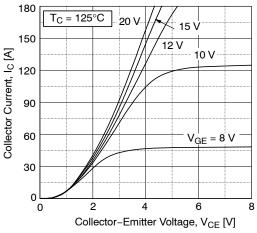
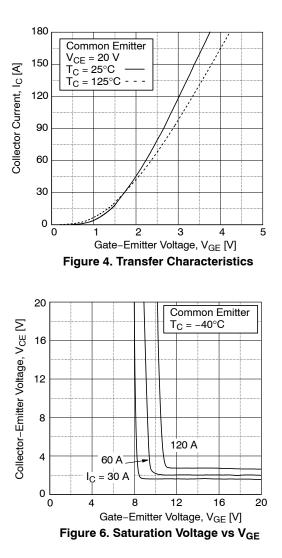


Figure 2. Typical Output Characteristics



TYPICAL PERFORMANCE CHARACTERISTICS (continued)

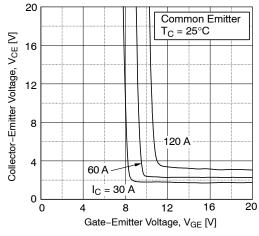
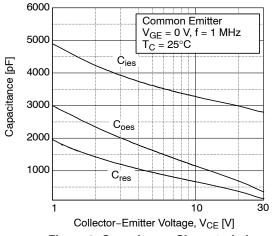
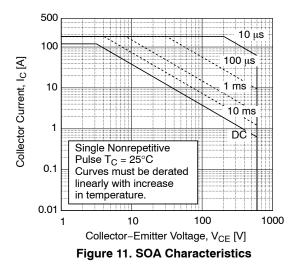


Figure 7. Saturation Voltage vs. V_{GE}







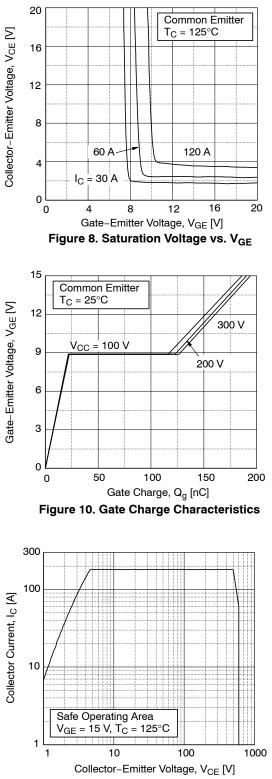


Figure 12. Turn-Off Switching SOA Characteristics

TYPICAL PERFORMANCE CHARACTERISTICS (continued)

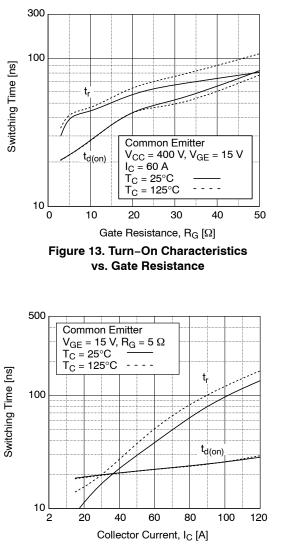


Figure 15. Turn–On Characteristics vs. Collector Current

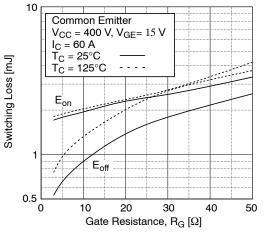


Figure 17. Switching Loss vs. Gate Resistance

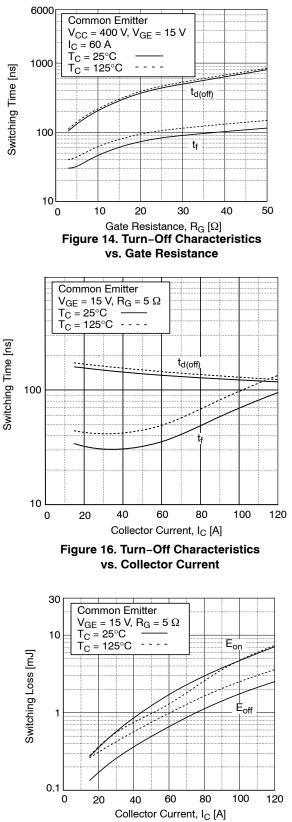
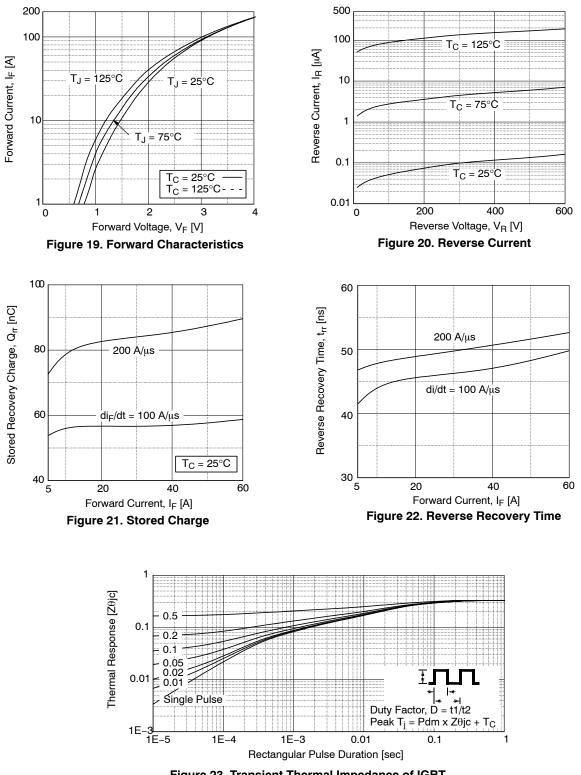


Figure 18. Switching Loss vs. Collector Current

TYPICAL PERFORMANCE CHARACTERISTICS (continued)







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